

## General Description

The WST4044 is the highest performance trench Dual N-ch MOSFETs with extreme high cell density, which provide excellent  $R_{DS(ON)}$  and gate charge for most of the synchronous buck converter applications.

The WST4044 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent  $CdV/dt$  effect decline
- 100% EAS Guaranteed
- Green Device Available

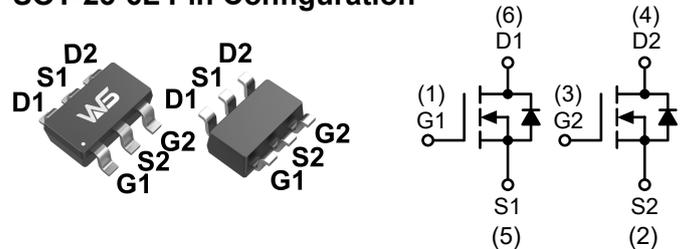
## Product Summary

| $BV_{DSS}$ | $R_{DS(ON)}$ | $I_D$ |
|------------|--------------|-------|
| 40V        | 28m $\Omega$ | 4.4A  |

## Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## SOT-23-6L Pin Configuration



## Absolute Maximum Ratings

| Symbol               | Parameter                             | Rating     | Units      |
|----------------------|---------------------------------------|------------|------------|
| $V_{DS}$             | Drain-Source Voltage                  | 40         | V          |
| $V_{GS}$             | Gate-Source Voltage                   | $\pm 20$   | V          |
| $I_D@T_C=25^\circ C$ | Continuous Drain Current <sup>1</sup> | 4.4        | A          |
| $I_D@T_C=70^\circ C$ | Continuous Drain Current <sup>1</sup> | 3.1        | A          |
| $I_{DM}$             | Pulsed Drain Current <sup>2</sup>     | 24         | A          |
| $P_D@T_A=25^\circ C$ | Total Power Dissipation <sup>3</sup>  | 1.9        | W          |
| $T_{STG}$            | Storage Temperature Range             | -55 to 150 | $^\circ C$ |
| $T_J$                | Operating Junction Temperature Range  | -55 to 150 | $^\circ C$ |

## Thermal Data

| Symbol          | Parameter  | Typ. | Max. | Unit         |
|-----------------|--|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient <sup>1</sup> | ---  | 125  | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 60   | $^\circ C/W$ |

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

| Symbol                              | Parameter                                      | Conditions   | Min. | Typ.  | Max. | Unit  |
|-------------------------------------|--|--|------|-------|------|-------|
| BV <sub>DSS</sub>                   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =250uA   | 40   | ---   | ---  | V     |
| ΔBV <sub>DSS</sub> /ΔT <sub>J</sub> | BV <sub>DSS</sub> Temperature Coefficient      | Reference to 25°C, I <sub>D</sub> =1mA   | ---  | 0.032 | ---  | V/°C  |
| R <sub>DS(ON)</sub>                 | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V, I <sub>D</sub> =3A   | ---  | 28    | H    | mΩ    |
|                                     |  | V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A  | ---  | 40    | I €  |       |
| V <sub>GS(th)</sub>                 | Gate Threshold Voltage                         | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA                               | 1.0  | 1.5   | 2.6  | V     |
| ΔV <sub>GS(th)</sub>                | V <sub>GS(th)</sub> Temperature Coefficient    |  | ---  | 4.5   | ---  | mV/°C |
| I <sub>DSS</sub>                    | Drain-Source Leakage Current                   | V <sub>DS</sub> =32V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C                        | ---  | ---   | 1    | uA    |
|                                     |  | V <sub>DS</sub> =32V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                        | ---  | ---   | 5    |       |
| I <sub>GSS</sub>                    | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V   | ---  | ---   | ±100 | nA    |
| g <sub>fs</sub>                     | Forward Transconductance                       | V <sub>DS</sub> =5V, I <sub>D</sub> =3A  | ---  | 8     | ---  | S     |
| R <sub>g</sub>                      | Gate Resistance                                | V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz                                       | ---  | 2.5   | ---  | Ω     |
| Q <sub>g</sub>                      | Total Gate Charge (4.5V)                       | V <sub>DS</sub> =20V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A                        | ---  | 5.0   | ---  | nC    |
| Q <sub>gs</sub>                     | Gate-Source Charge                             |  | ---  | 1.5   | ---  |       |
| Q <sub>gd</sub>                     | Gate-Drain Charge                              |  | ---  | 1.84  | ---  |       |
| T <sub>d(on)</sub>                  | Turn-On Delay Time                             | V <sub>DD</sub> =20V, V <sub>GS</sub> =10V, R <sub>G</sub> =3.3Ω<br>I <sub>D</sub> =1A | ---  | 2.1   | ---  | ns    |
| T <sub>r</sub>                      | Rise Time                                      |  | ---  | 7.8   | ---  |       |
| T <sub>d(off)</sub>                 | Turn-Off Delay Time                            |  | ---  | 2.1   | ---  |       |
| T <sub>f</sub>                      | Fall Time                                      |  | ---  | 29    | ---  |       |
| C <sub>iss</sub>                    | Input Capacitance                              | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz                                      | ---  | 452   | ---  | pF    |
| C <sub>oss</sub>                    | Output Capacitance                             |  | ---  | 51    | ---  |       |
| C <sub>rss</sub>                    | Reverse Transfer Capacitance                   |  | ---  | 38    | ---  |       |

**Guaranteed Avalanche Characteristics**

| Symbol | Parameter                                  | Conditions   | Min. | Typ. | Max. | Unit |
|--------|--|--|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy <sup>5</sup> | V <sub>DD</sub> =20V, L=0.5mH, I <sub>AS</sub> =6A | 20   | ---  | ---  | mJ   |

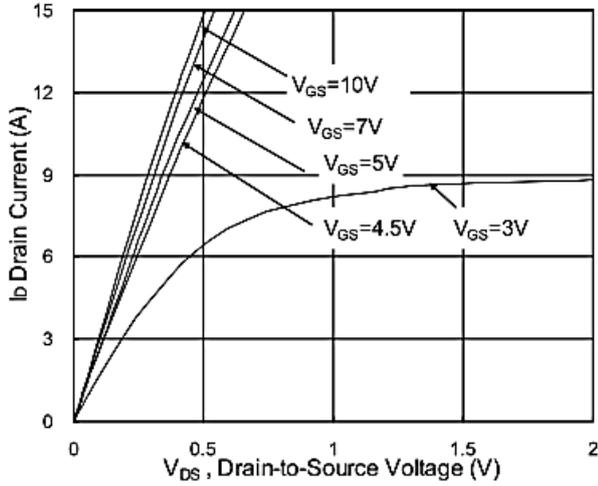
**Diode Characteristics**

| Symbol          | Parameter                                | Conditions  | Min. | Typ. | Max. | Unit |
|-----------------|--|---|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current <sup>1,6</sup> | V <sub>G</sub> =V <sub>D</sub> =0V, Force Current             | ---  | ---  | 4.5  | A    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,6</sup>     |   | ---  | ---  | 14   | A    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C | ---  | ---  | 1.2  | V    |
| t <sub>rr</sub> | Reverse Recovery Time                    | I <sub>F</sub> =2A, dI/dt=100A/μs, T <sub>J</sub> =25°C       | ---  | 22   | ---  | nS   |
| Q <sub>rr</sub> | Reverse Recovery Charge                  | I <sub>F</sub> =2A, dI/dt=100A/μs, T <sub>J</sub> =25°C       | ---  | 75   | ---  | nC   |

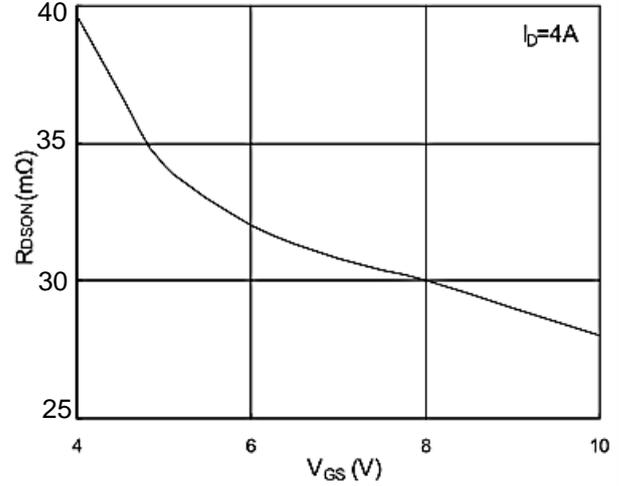
Note :

- The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper, t<10sec.
- The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%
- The EAS data shows Max. rating. The test condition is V<sub>DD</sub>=20V, V<sub>GS</sub>=10V, L=0.5mH, I<sub>AS</sub>=6A
- The power dissipation is limited by 150°C junction temperature
- The Min. value is 100% EAS tested guarantee.
- The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.

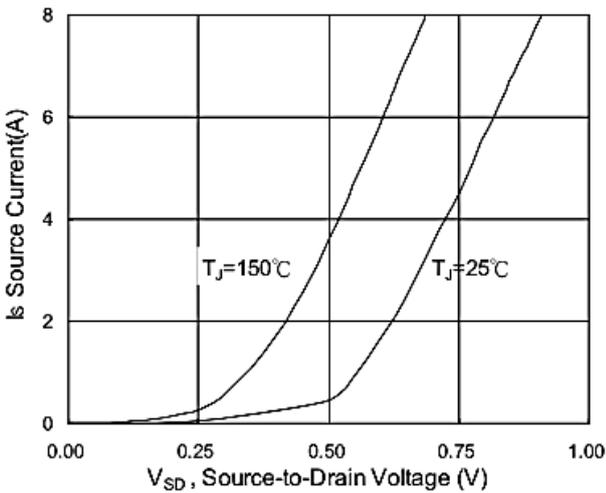
**Typical Characteristics**



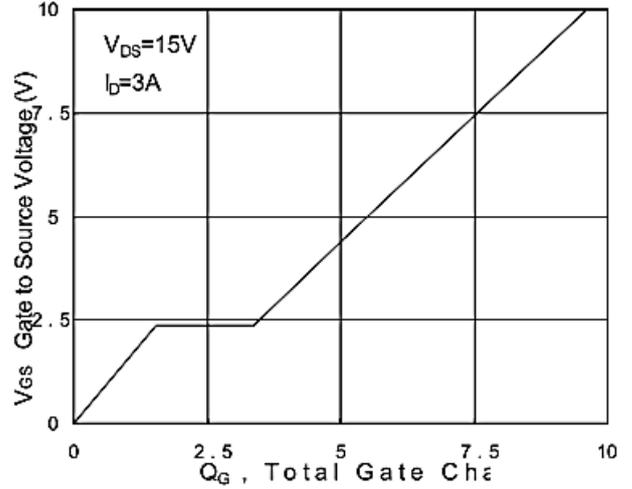
**Fig.1 Typical Output Characteristics**



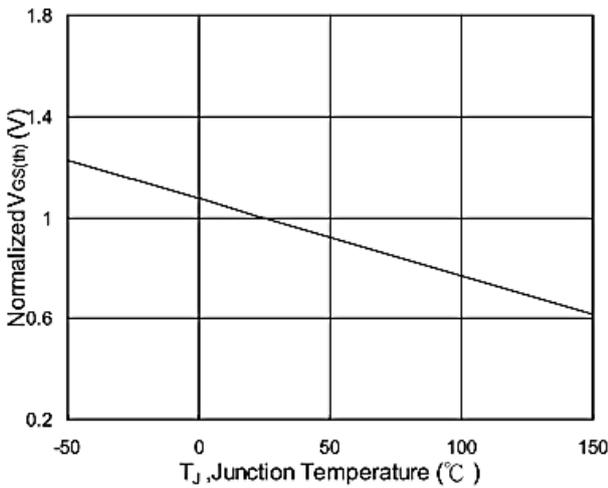
**Fig.2 On-Resistance vs. Gate-Source**



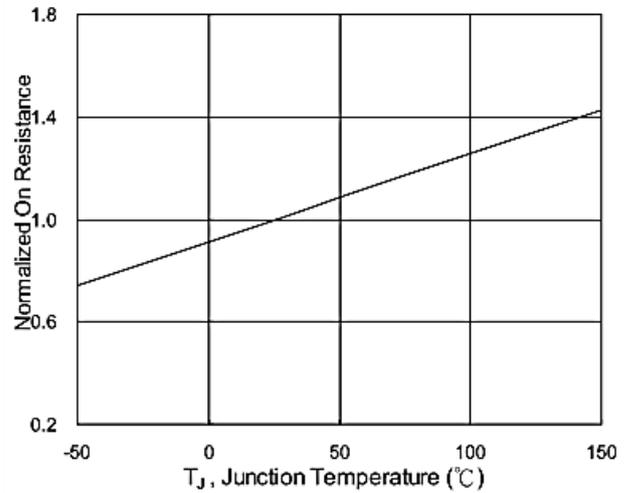
**Fig.3 Forward Characteristics Of Reverse**



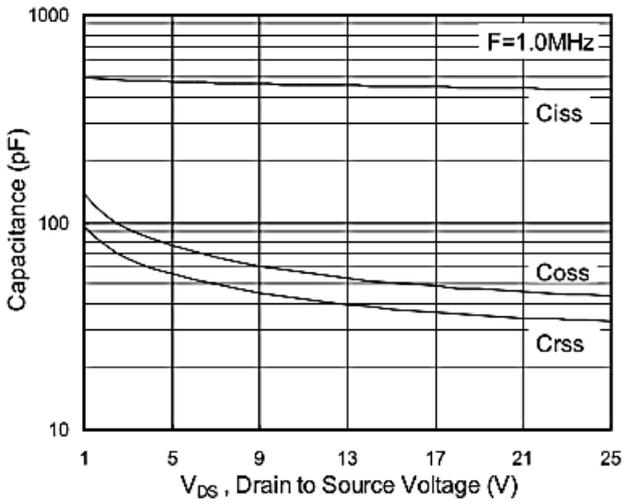
**Fig.4 Gate-Charge Characteristics**



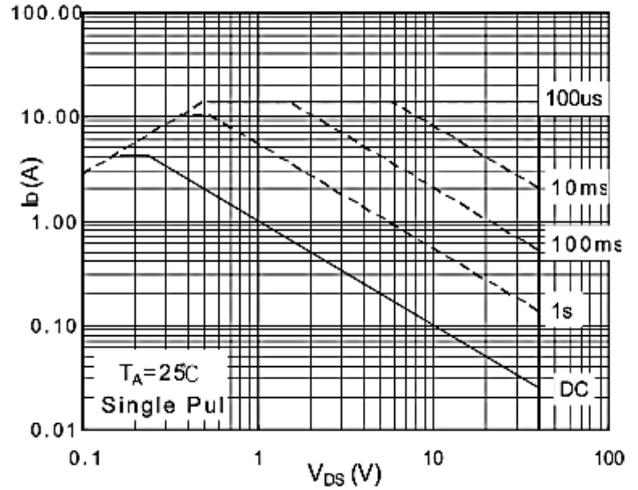
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



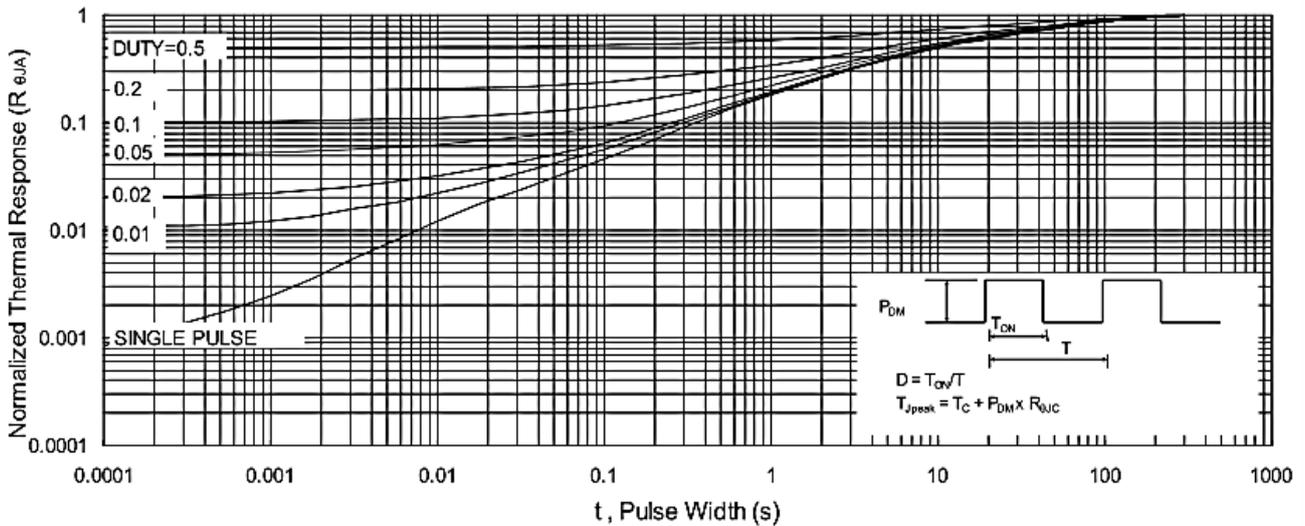
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



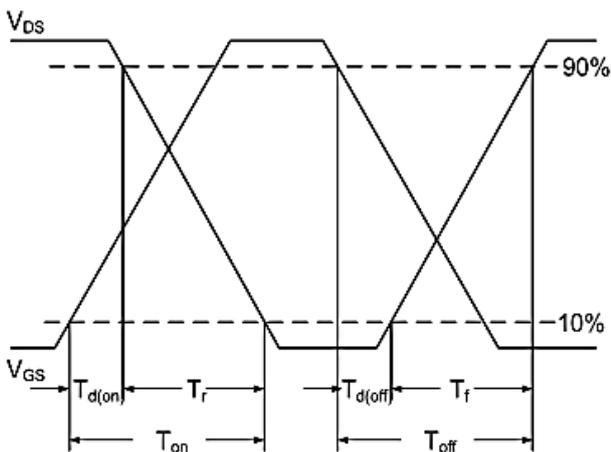
**Fig.7 Capacitance**



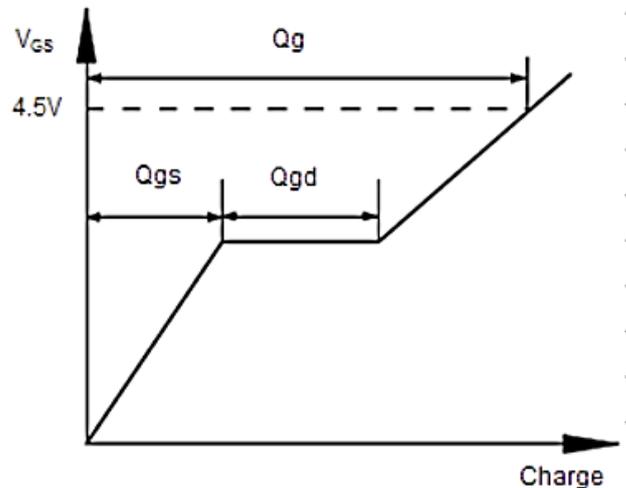
**Fig.8 Safe Operating Area**



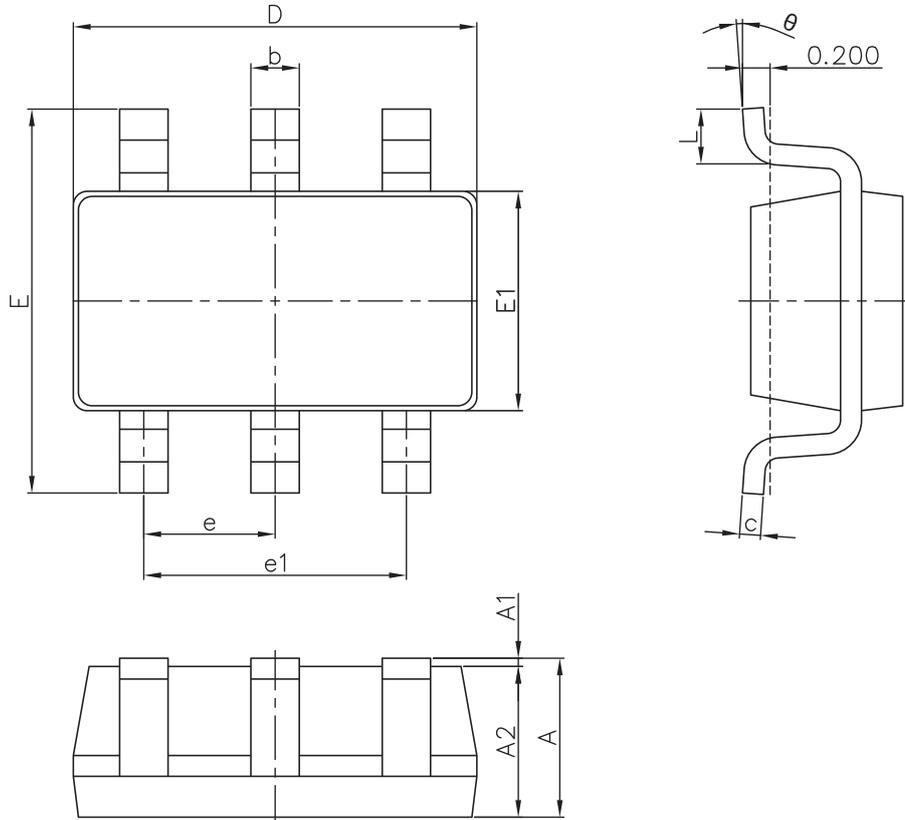
**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Gate Charge Waveform**

**Packaging information**


| Symbol   | Dimensions In Millimeters |       | Dimensions In Inches |       |
|----------|---------------------------|-------|----------------------|-------|
|          | Min.                      | Max.  | Min.                 | Max.  |
| A        | 1.050                     | 1.250 | 0.041                | 0.049 |
| A1       | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2       | 1.050                     | 1.150 | 0.041                | 0.045 |
| b        | 0.300                     | 0.500 | 0.012                | 0.020 |
| c        | 0.100                     | 0.200 | 0.004                | 0.008 |
| D        | 2.820                     | 3.020 | 0.111                | 0.119 |
| E1       | 1.500                     | 1.700 | 0.059                | 0.067 |
| E        | 2.650                     | 2.950 | 0.104                | 0.116 |
| e        | 0.950(BSC)                |       | 0.037(BSC)           |       |
| e1       | 1.800                     | 2.000 | 0.071                | 0.079 |
| L        | 0.300                     | 0.600 | 0.012                | 0.024 |
| $\theta$ | 0°                        | 8°    | 0°                   | 8°    |



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